

TOSHIBA PHOTOCOUPLER

TLP665(D4)SERIESATTACHMENT : SPECIFICATIONS FOR VDE0884 OPTION : (D4)

Types : TLP665G, TLP665J, TLP665GF, TLP665JF, TLP666G, TLP666J, TLP666GF, TLP666JF

Type designations for 'Option : (D4)', which are tested under VDE0884 requirements.

Ex. : TLP665G (D4-T7)

D4 : VDE0884 option

T7 : I_{FT} rank name

Note : Use Toshiba standard type number for safety standard application.

Ex. TLP665G (D4-T7) → TLP665G, TLP666JF (D4) → TLP666JF

VDE0884 ISOLATION CHARACTERISTICS

DESCRIPTION	SYMBOL	RATING	UNIT
Application Classification (DIN VDE0109 / 12.83, Table 1) for rated mains voltage $\leq 300V_{rms}$ for rated mains voltage $\leq 600V_{rms}$		I-IV I-III	—
Climatic Classification (DIN IEC68 Teil 1 / 09.80)		55 / 100 / 21	—
Pollution Degree (DIN VDE0109 / 12.83)		2	—
Maximum Operating Insulation Voltage	V _{IORM}	630	V _{pk}
Input to output Test Voltage, Method A V _{pr} = 1.2 × V _{IORM} , Type and Sample Test t _p = 60s, Partial Discharge < 5pC	V _{pr}	760	V _{pk}
Input to output Test Voltage, Method B V _{pr} = 1.6 × V _{IORM} , 100% Production Test t _p = 1s, Partial Discharge < 5pC	V _{pr}	1000	V _{pk}
Highest Permissible Overvoltage (Transient Overvoltage, t _{pr} = 10s)	V _{TR}	6000	V _{pk}
Safety Limiting Values (Max. permissible ratings in case of fault, also refer to thermal derating curve)			
Current (Input current I _F , P _{si} = 0)	I _{si}	400	mA
Power (Output or Total Power Dissipation)	P _{si}	700	mW
Temperature	T _{si}	150	°C
Insulation Resistance at T _{si} , V _{IO} = 500V	R _{si}	$\geq 10^9$	Ω

INSULATION RELATED SPECIFICATIONS

		 7.62mm pitch TLPxxx type	 10.16mm pitch TLPxxxF type
Minimum Creepage Distance (*)	Cr	7.0mm	8.0mm
Minimum Clearance (*)	Cl	7.0mm	8.0mm
Minimum Insulation Thickness	ti	0.5mm	
Comperative Tracking Index (DIN IEC112 / VDE0303, Part 1)	CTI	175 (VDE0109 / 12.83 Group III a)	

((*) in accordance with DIN VDE0109 / 12.83, Table 2, & 4)

(*1) If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value (e. g. at a standard distance between soldering eye centres of 7.5mm). If this is not permissible, the user shall take suitable measures.

(*2) This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data.

Maintenance of the safety data shall be ensured by means of protective circuits.

VDE Test sign : Marking on product
for VDE0884



Marking on packing
for VDE0884



0884

Figure 1 Partial discharge measurement procedure according to VDE0884
Destructive test for qualification and sampling tests.

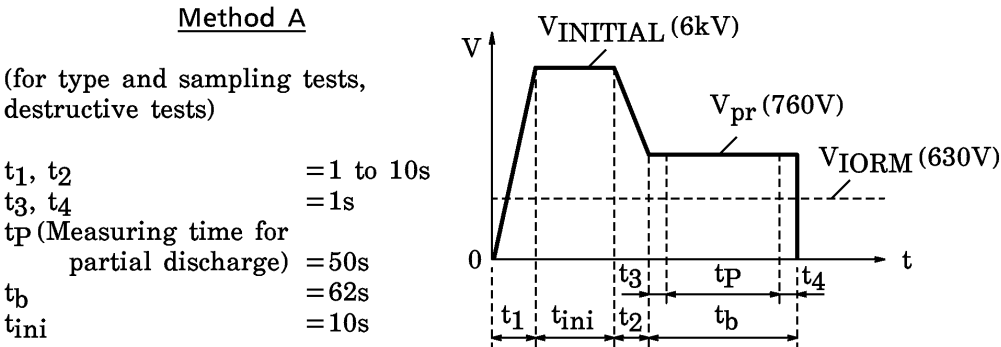


Figure 2 Partial discharge measurement procedure according to VDE0884
Non-destructive test for 100% inspection.

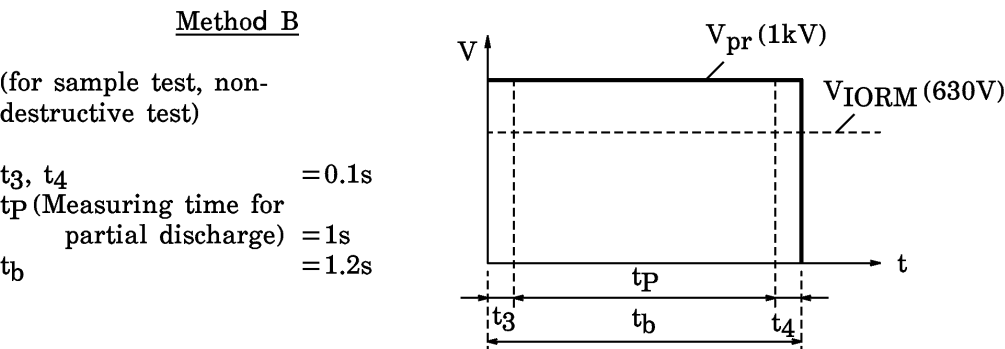
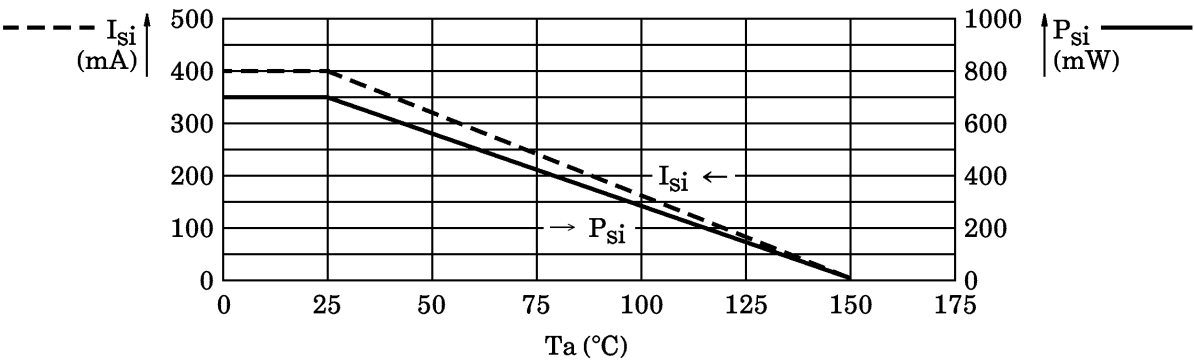


Figure 3 Dependency of maximum safety ratings on ambient temperature



RESTRICTIONS ON PRODUCT USE

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